Vishay General Semiconductor

# Surface-Mount Ultrafast Plastic Rectifier



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SMB (DO-214AA) Cathode O Anode

## LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	2.0 A				
V <sub>RRM</sub>	300 V, 400 V				
I <sub>FSM</sub>	50 A				
t <sub>rr</sub>	35 ns				
V <sub>F</sub>	1.1 V				
T <sub>J</sub> max.	150 °C				
Package	SMB (DO-214AA)				
Circuit configuration	Single				

## **FEATURES**

- · Glass passivated pellet chip junction
- · Ideal for automated placement
- Ultrafast reverse recovery time
- · Low switching losses, high efficiency
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

## **TYPICAL APPLICATIONS**

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, and telecommunication.

## **MECHANICAL DATA**

Case: SMB (DO-214AA) Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	ES2F	ES2G	UNIT	
Device marking code		EF	EG		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	300	400	V	
Working peak reverse voltage	V <sub>RWM</sub>	225	300	V	
Maximum RMS voltage	V <sub>RMS</sub>	210	280	V	
Maximum average forward rectified current at T <sub>L</sub> = 110 °C	I <sub>F(AV)</sub>	2.0		A	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	50		A	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150		°C	





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<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	ES2F	ES2G	UNIT	
Maximum instantaneous forward voltage	2.0 A		V <sub>F</sub> <sup>(1)</sup>	1.	.1	V	
Maximum reverse autrent at V	$T_A = 25 \text{ °C}$	10					
Maximum reverse current at V <sub>RRM</sub>		T <sub>A</sub> = 100 °C	IR	200		μA	
Maximum reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t <sub>rr</sub>	35		ns	
Maximum reverse recovery time	$I_{F} = 1.0 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}, \\ V_{R} = 30 \text{ V}, I_{rr} = 0.1 I_{RM}$		t <sub>rr</sub>	50		ns	
Maximum reverse recovery current	$I_F = 1.0$ A, dl/dt = 100 A/µs, V_R = 30 V, $I_{rr} = 0.1$ $I_{RM}$		I <sub>RM</sub>	3.0		А	
Maximum stored charge	$I_{F} = 1.0 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \\ V_{R} = 30 \text{ V}, I_{rr} = 0.1 \text{ I}_{RM}$		Q <sub>rr</sub>	50		nC	
Typical junction capacitance	4.0 V, 1 MHz		CJ	15		pF	

#### Note

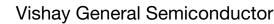
 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	SYMBOL	ES2F	ES2G	UNIT		
Maximum thermal resistance	$R_{\theta JA}$ <sup>(1)</sup>	75		°C/W		
	R <sub>0JL</sub> <sup>(1)</sup>	25				

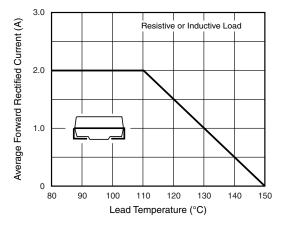
### Note

 $^{(1)}\,$  Units mounted on PCB 5.0 mm x 5.0 mm (0.013 mm thick) land areas

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
ES2G-M3/52T	0.096	52T	750	7" diameter plastic tape and reel		
ES2G-M3/5BT	0.096	5BT	3200	13" diameter plastic tape and reel		



## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)



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Fig. 1 - Maximum Forward Current Derating Curve

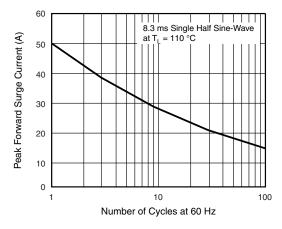


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

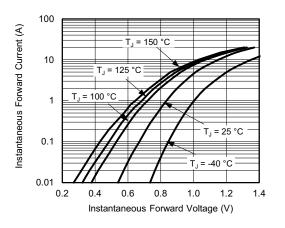


Fig. 3 - Typical Instantaneous Forward Characteristics

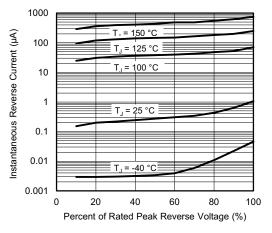


Fig. 4 - Typical Reverse Leakage Characteristics

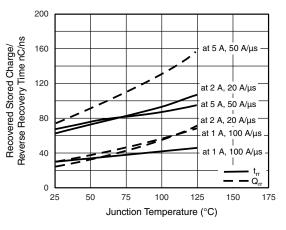


Fig. 5 - Reverse Switching Characteristics

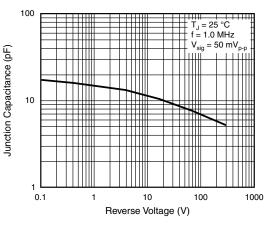


Fig. 6 - Typical Junction Capacitance

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- 0.085 (2.159) MAX.

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Mounting Pad Layout

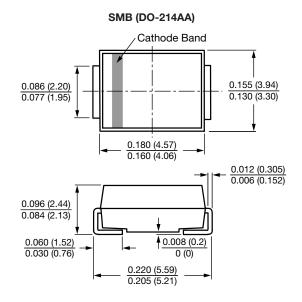
--- 0.220 (5.59) REF. ---

0.086 (2.18) MIN

0.060 (1.52) MIN.

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## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



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